

C0603X682K5HACTU

Aliases (C0603X682K5HAC7867)

SMD Comm X8R HT150C Flex, Ceramic, 6,800 pF, 10%, 50 VDC, X8R, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.4 mm



General Information	
Series	SMD Comm X8R HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	7.3 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0603
L	1.6mm +/-0.17mm
W	0.8mm +/-0.15mm
Т	0.8mm +/-0.15mm
S	0.4mm MIN
В	0.45mm +/-0.15mm
	,

4000

Packaging Quantity

	,		
W	0.8mm +/-0.15mm	Tolerance	10%
Т	0.8mm +/-0.15mm	Voltage DC	50 VDC
S	0.4mm MIN	Dielectric Withstanding Voltage	125 VDC
В	0.45mm +/-0.15mm	Temperature Range	-55/+150°
		Temp. Coefficient	X8R
Packaging Specifications		Capacitance Change with	15%, 1kHz
Packaging	T&R, 180mm, Paper Tape	Reference to +25°C and 0 VDC Applied (TCC)	

Specifications	
Capacitance	6,800 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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